

N-CHANNEL ENHANCEMENT MODE MOSFET WITH SCHOTTKY DIODE

Product Summary

V _{(BR)DSS}	R _{DS(on)}	I_D max $T_A = 25$ °C (Note 5)		
30V	12.5mΩ @ V _{GS} = 10V	11.7A		
	14.8mΩ @ V _{GS} = 4.5V	10.8A		

Features

- DIOFET utilizes a unique patented process to monolithically integrate a MOSFET and a Schottky in a single die to deliver:
 - Low R_{DS(ON)} minimizes conduction losses
 - Low V_{SD} reducing the losses due to body diode conduction
 - Low Q_{rr} lower Q_{rr} of the integrated Schottky reduces body diode switching losses
 - Low gate capacitance (Q_g/Q_{gs}) ratio reduces risk of shootthrough or cross conduction currents at high frequencies
 - Avalanche rugged I_{AR} and E_{AR} rated
- Lead Free, RoHS Compliant (Note 1)
- "Green" Device (Note 2)
- Qualified to AEC-Q101 Standards for High Reliability

Description and Applications

This new generation MOSFET has been designed to minimize the onstate resistance ($R_{DS(on)}$) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

- DC-DC Converters
- Power management functions

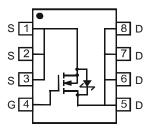
Mechanical Data

- Case: SO-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram Below
- Weight: 0.072 grams (approximate)





Top View



Top View Internal Schematic

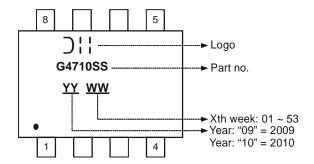
Ordering Information (Note 3)

Part Number	Case	Packaging
DMG4710SSS-13	SO-8	2500 / Tape & Reel

Notes:

- 1. No purposefully added lead.
- 2. Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com.
- 3. For packaging details, go to our website at http://www.diodes.com.

Marking Information





Maximum Ratings @TA = 25°C unless otherwise specified

Character	Symbol	Value	Unit		
Drain-Source Voltage			V _{DSS}	30	V
Gate-Source Voltage			V _{GSS}	±12	V
Continuous Drain Current (Note 4) V _{GS} = 10V	Steady State	TA = 25°C TA = 85°C	I _D	8.8 6.3	А
Continuous Drain Current (Note 5) V _{GS} = 10V	$t \le 10 \text{ sec}$	TA = 25°C TA = 85°C	I _D	11.7 8.5	А
Continuous Drain Current (Note 5) $V_{GS} = 4.5V$ $t \le 10 \text{ sec}$ $TA = 25^{\circ}C$ $TA = 85^{\circ}C$			I _D	10.8 7.8	А
Pulsed Drain Current (Note 6)	I _{DM}	90	Α		
Avalanche Current (Notes 6 & 7)			I _{AR}	13	Α
Repetitive Avalanche Energy (Notes 6 & 7) L = 0.3mH			E _{AR}	25.4	mJ

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 4)	P _D	1.54	W
Thermal Resistance, Junction to Ambient @T _A = 25°C (Note 4)	$R_{\theta JA}$	81	°C/W
Power Dissipation (Note 5)	P _D	2.8	W
Thermal Resistance, Junction to Ambient @T _A = 25°C (Note 5)	$R_{\theta JA}$	45	°C/W
Operating and Storage Temperature Range	T_{J}, T_{STG}	-55 to +150	°C

Electrical Characteristics @ T_A = 25°C unless otherwise stated

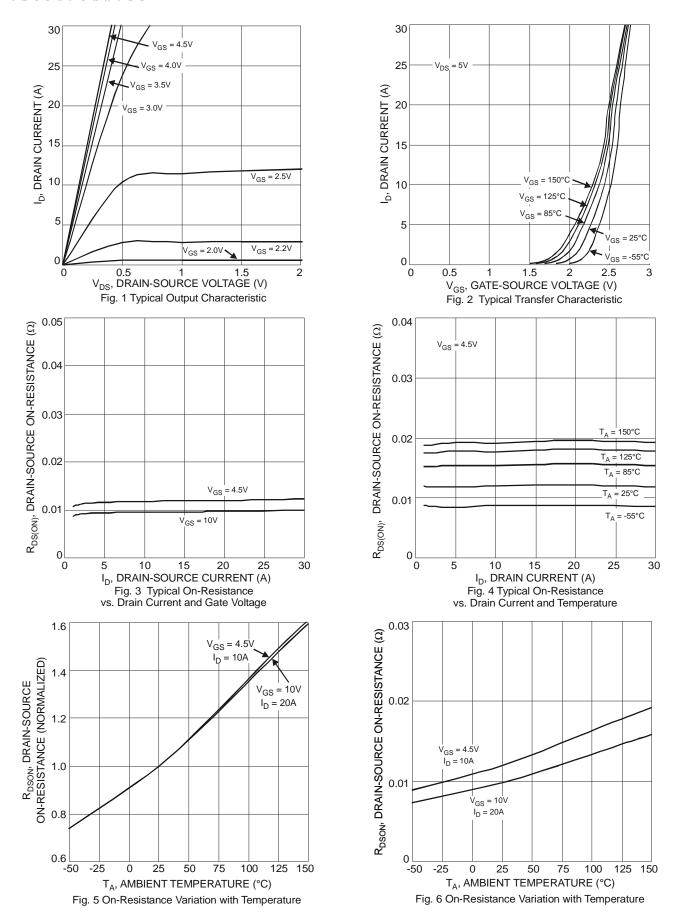
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)							
Drain-Source Breakdown Voltage	BV _{DSS}	30	-	-	V	$V_{GS} = 0V$, $I_D = 1mA$	
Zero Gate Voltage Drain Current	I _{DSS}	-	-	0.1	mA	$V_{DS} = 30V, V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}	-	-	±100	nA	$V_{GS} = \pm 12V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 8)							
Gate Threshold Voltage	$V_{GS(th)}$	1.0	-	2.3	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$	
Static Drain-Source On-Resistance		-	9.5	12.5	mΩ	$V_{GS} = 10V, I_D = 11.7A$	
Static Drain-Source Off-Resistance	R _{DS (ON)}	-	11.5	14.8	111 2 2	$V_{GS} = 4.5V, I_D = 10.8A$	
Forward Transfer Admittance	Y _{fs}	-	22	-	S	$V_{DS} = 5V, I_{D} = 11.7A$	
Diode Forward Voltage	V_{SD}	-	0.38	0.6	V	$V_{GS} = 0V, I_{S} = 1A$	
Maximum Body-Diode + Schottky Continuous Current	IS	-	-	5	Α	-	
DYNAMIC CHARACTERISTICS (Note 9)							
Input Capacitance	C _{iss}	-	1849	-	pF	., .=., .,	
Output Capacitance	Coss	-	158	-	pF	$V_{DS} = 15V, V_{GS} = 0V,$ of = 1.0MHz	
Reverse Transfer Capacitance	C_{rss}	-	123	-	pF	1 – 1.01011 12	
Gate Resistance	R_{g}	0.54	2.68	4.82	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge V _{GS} = 4.5V	Qg	-	18.5	-	nC		
Total Gate Charge V _{GS} = 10V	Qg	-	43	-	nC	$V_{DS} = 15V, V_{GS} = 10V,$	
Gate-Source Charge	Qgs	-	4.7	-	nC	I _D = 11.7A	
Gate-Drain Charge	Q_{gd}	-	4.0	-	nC		
Turn-On Delay Time	t _{D(on)}	-	6.62	-	ns		
Turn-On Rise Time	t _r	-	8.73	-	ns	V _{GS} = 10V, V _{DS} = 10V,	
Turn-Off Delay Time	t _{D(off)}	-	36.41	-	ns	$R_G = 3\Omega$, $R_L = 1.2\Omega$	
Turn-Off Fall Time	t _f	-	4.69	-	ns	1	

4. Device mounted on FR-4 PCB with minimum recommended pad layout. The value in any given application depends on the user's specific board design.

5. Device mounted on 1" x 1" FR-4 PCB with high coverage 1 oz. Copper, single sided , device is measured at t ≤ 10 sec.

S. Device intollined of T X T TAP TO Built Inflight Coverage T 02. Copper, single side.
Repetitive rating, pulse width limited by junction temperature.
I_{AR} and E_{AR} rating are based on low frequency and duty cycles to keep T_J = 25°C
Short duration pulse test used to minimize self-heating effect.
Guaranteed by design. Not subject to production testing.







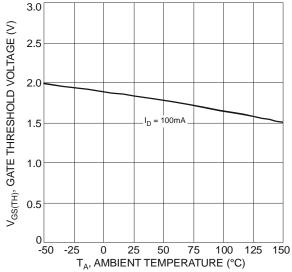
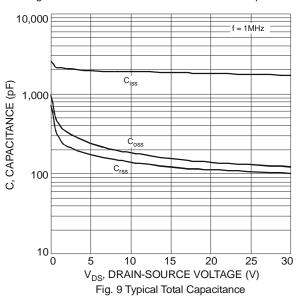
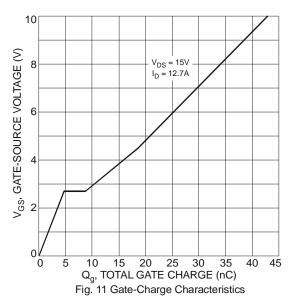
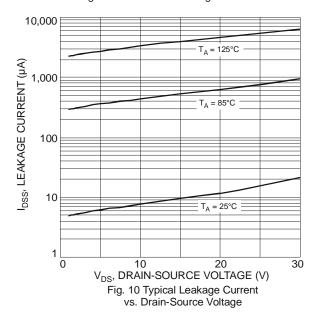


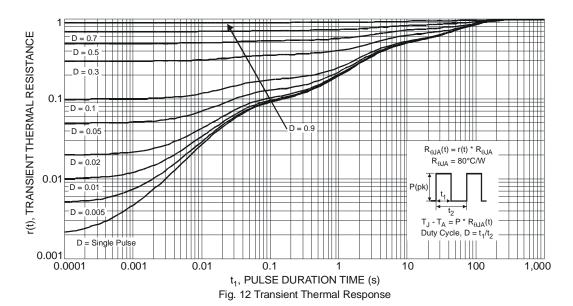
Fig. 7 Gate Threshold Variation vs. Ambient Temperature



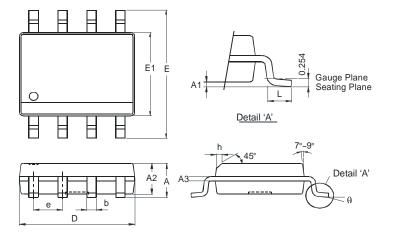






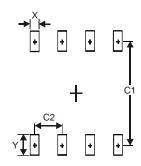


Package Outline Dimensions



SO-8				
Dim	Min	Max		
Α	-	1.75		
A 1	0.10	0.20		
A2	1.30	1.50		
А3	0.15	0.25		
b	0.3	0.5		
D	4.85	4.95		
Е	5.90	6.10		
E1	3.85	3.95		
е	1.27 Typ			
h	-	0.35		
L	0.62	0.82		
θ	0°	8°		
All Dimensions in mm				

Suggested Pad Layout



Dimensions	Value (in mm)
Х	0.60
Y	1.55
C1	5.4
C2	1.27



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